



产品规格手册

PRODUCT SPECIFICATION MANUAL

SI2305

P Channel Advanced Power MOSFET
SOT23/-20V/-4.2A



深圳东为电子科技有限公司
DONGWEI ELECTRONIC TECHNOLOGY CO.,LTD

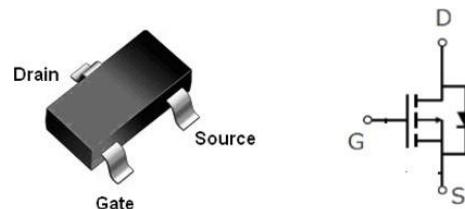
Features

- Low $R_{DS(on)}$ @ $V_{GS}=-4.5V$
- -3.3V Logic Level Control
- P Channel SOT23 Package
- Pb-Free, RoHS Compliant

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D Max
-20V	38mΩ @-4.5V	-4.2A
	42mΩ @-3.3V	

Applications

- Charging switch for portable devices
- Small brushless DC motor drive
- Load Switch for Portable Devices
- DC-to-DC converters
- Power Management Functions

**SOT23****Order Information**

Product	Package	Marking	Packing	Min Unit Quantity
SI2305	SOT23	S5	3000PCS/Reel	3000PCS

Absolute Maximum Ratings

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
Common Ratings (TA=25°C Unless Otherwise Noted)			
V_{GS}	Gate-Source Voltage	±12	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	-20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 150	°C

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested①	$T_A = 25^\circ C$	-16.8	A
I_D	Continuous Drain Current	$T_A = 25^\circ C$	-4.2	A
		$T_A = 70^\circ C$	-2.8	
P_D	Maximum Power Dissipation	$T_A = 25^\circ C$	1.25	W
		$T_A = 70^\circ C$	1	
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		100	°C/W



Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_D=-250\mu\text{A}$	-20	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current($T_A=25^\circ\text{C}$)	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$	--	--	-1	μA
	Zero Gate Voltage Drain Current($T_A=125^\circ\text{C}$)	$V_{\text{DS}}=-16\text{V}$, $V_{\text{GS}}=0\text{V}$	--	--	-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 10\text{V}$, $V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=-250\mu\text{A}$	-0.4	-0.7	-1.0	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=-4.5\text{V}$, $I_D=-4\text{A}$	--	29	38	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=-3.3\text{V}$, $I_D=-3\text{A}$	--	35	42	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=-2.5\text{V}$, $I_D=-2\text{A}$	--	45	60	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-10\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	--	760	--	pF
C_{oss}	Output Capacitance		--	94	--	pF
C_{rss}	Reverse Transfer Capacitance		--	76	--	pF
R_g	Gate Resistance	$f=1\text{MHz}$		16		Ω
Q_g	Total Gate Charge	$V_{\text{DS}}=-10\text{V}$ $I_D=-3\text{A}$, $V_{\text{GS}}=-4.5\text{V}$	--	7.6	--	nC
Q_{gs}	Gate Source Charge		--	0.9	--	nC
Q_{gd}	Gate Drain Charge		--	1.8	--	nC
Switching Characteristics						
$t_{\text{d}(\text{on})}$	Turn on Delay Time	$V_{\text{DD}}=-10\text{V}$, $I_D=-2\text{A}$, $R_G=3.3\Omega$, $V_{\text{GS}}=-4.5\text{V}$	--	5.5	--	ns
t_r	Turn on Rise Time		--	3.9	--	ns
$t_{\text{d}(\text{off})}$	Turn Off Delay Time		-	11.3	--	ns
t_f	Turn Off Fall Time		--	36	--	ns
Source Drain Diode Characteristics						
I_{SD}	Source drain current(Body Diode)	$T_A=25^\circ\text{C}$	--	--	-2	A
V_{SD}	Forward on voltage②	$T_J=25^\circ\text{C}$, $I_{\text{SD}}=-4\text{A}$, $V_{\text{GS}}=0\text{V}$	--	-0.87	-1.2	V

Notes:

① Pulse width limited by maximum allowable junction temperature



Typical Characteristics

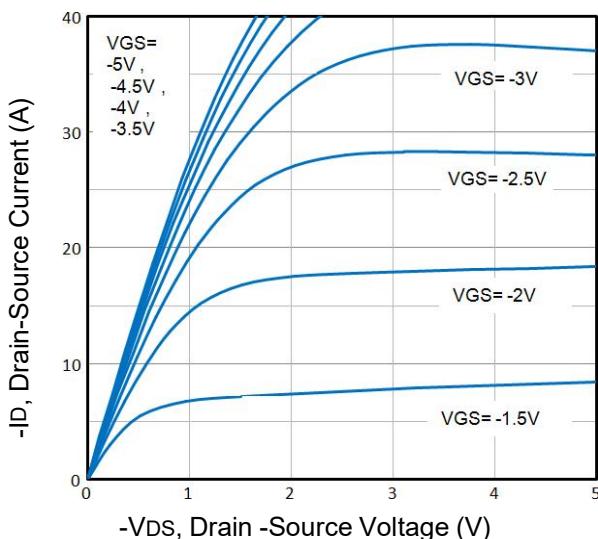


Fig1. Typical Output Characteristics

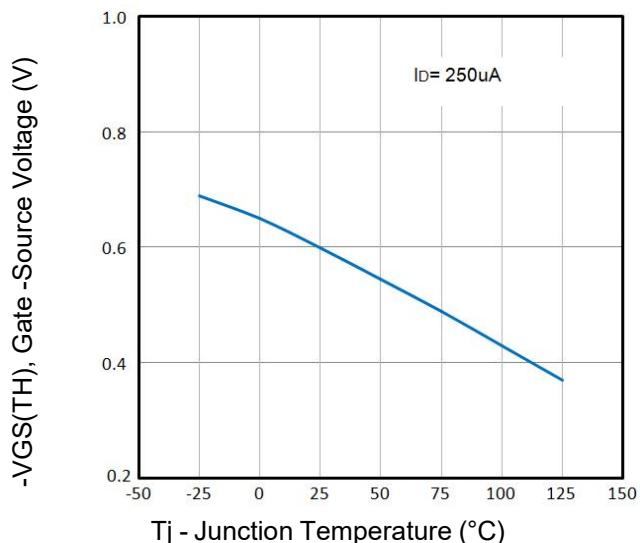


Fig2. Normalized Threshold Voltage Vs. Temperature

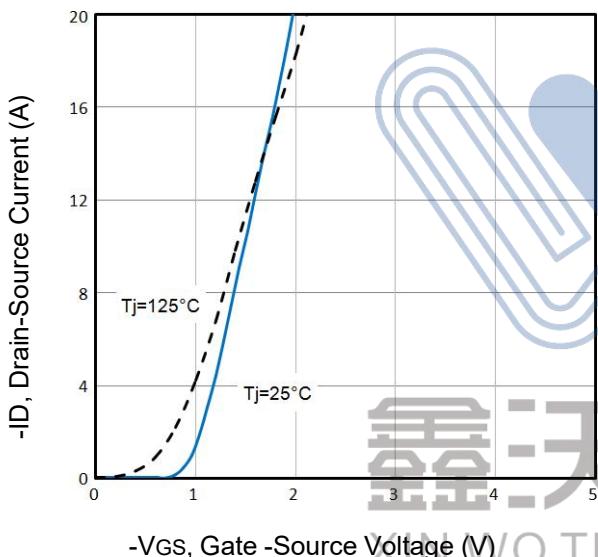


Fig3. Typical Transfer Characteristics

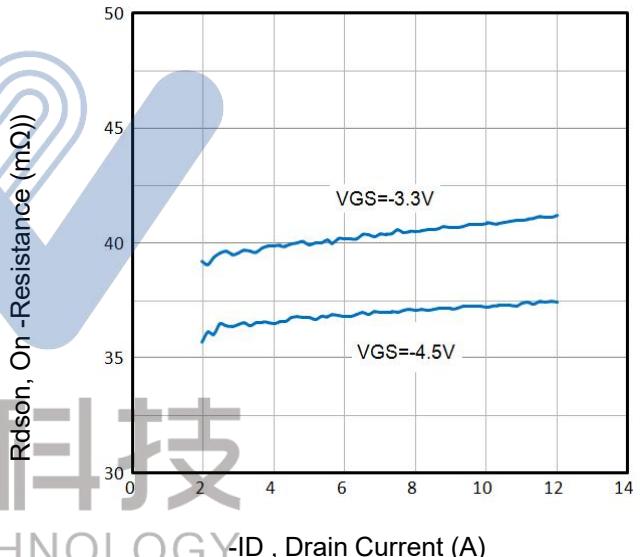


Fig4. On-Resistance vs. Drain Current and Gate Voltage

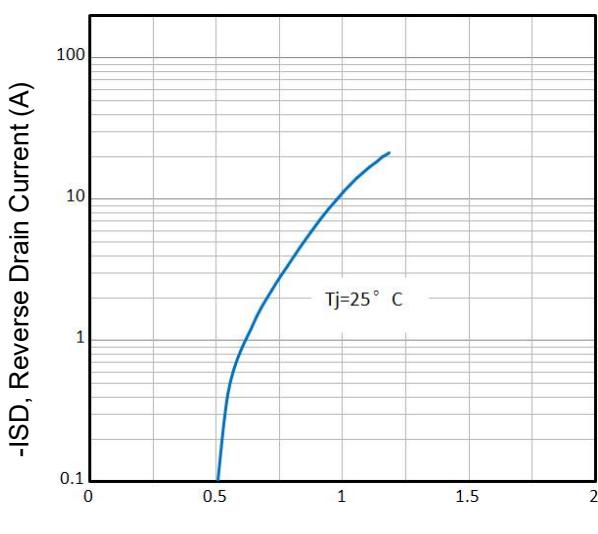


Fig5. Typical Source-Drain Diode Forward Voltage

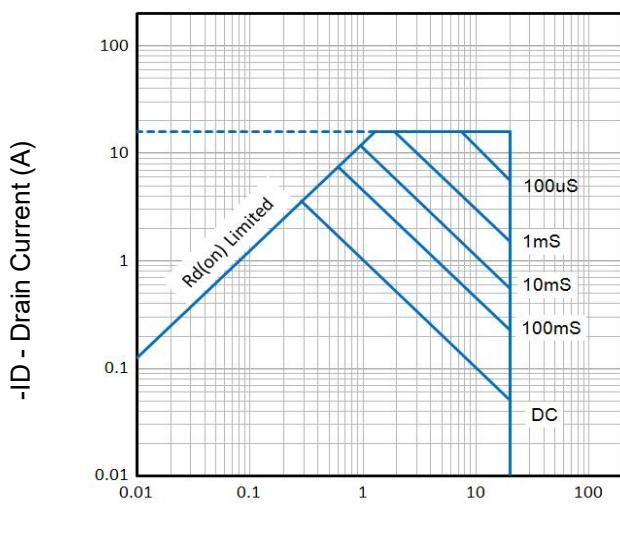


Fig6. Maximum Safe Operating Area

Typical Characteristics

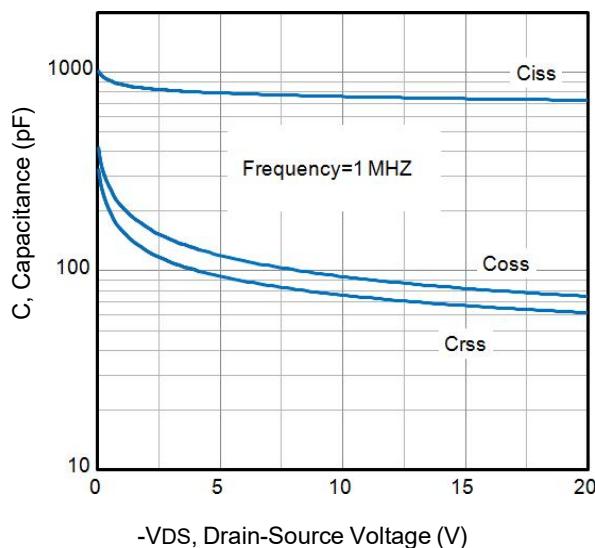


Fig7. Typical Capacitance Vs. Drain-Source Voltage

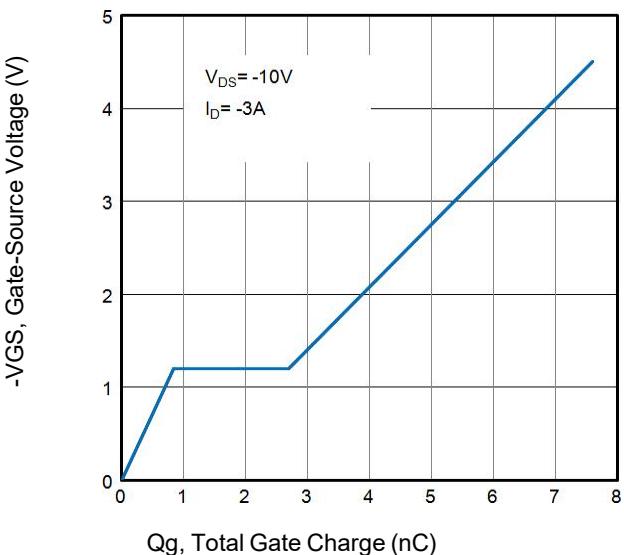


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

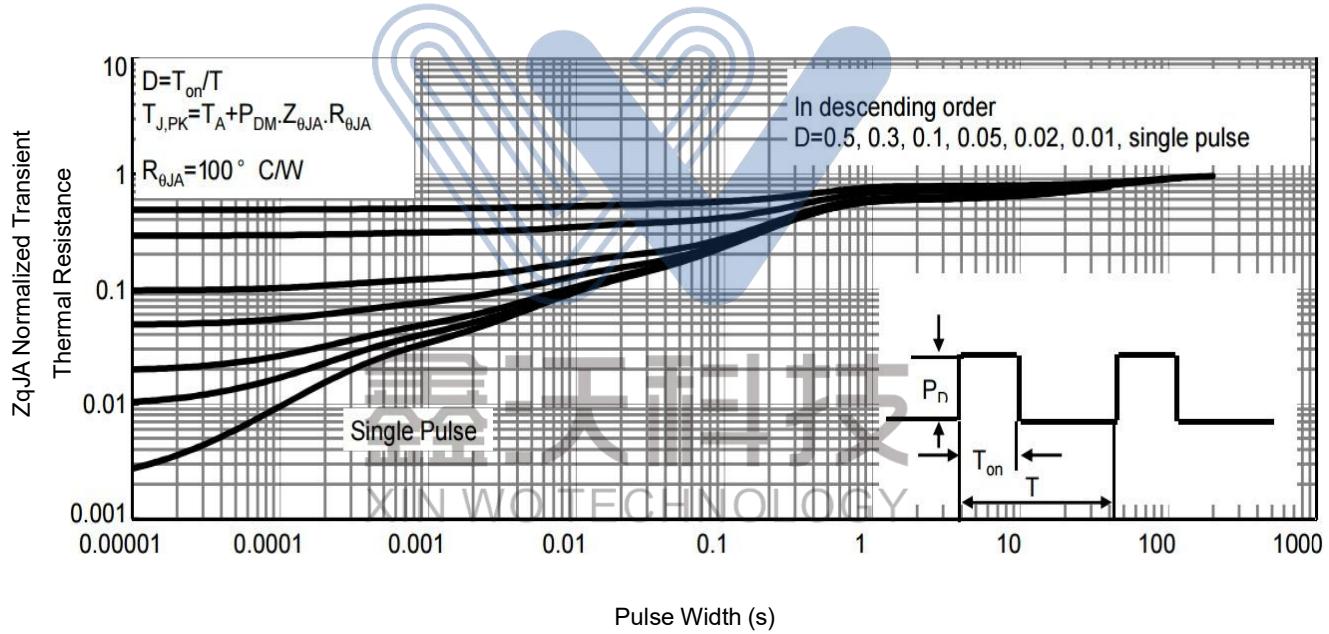


Fig9. Normalized Maximum Transient Thermal Impedance

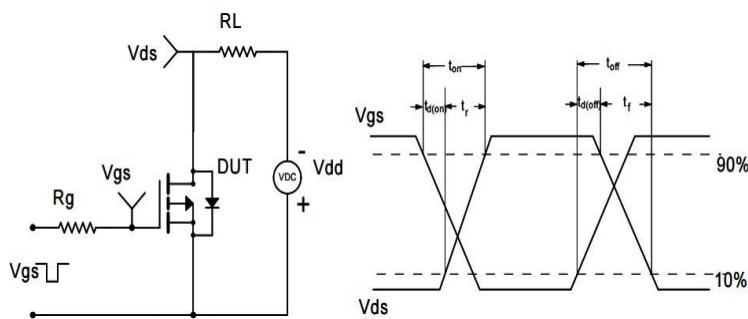
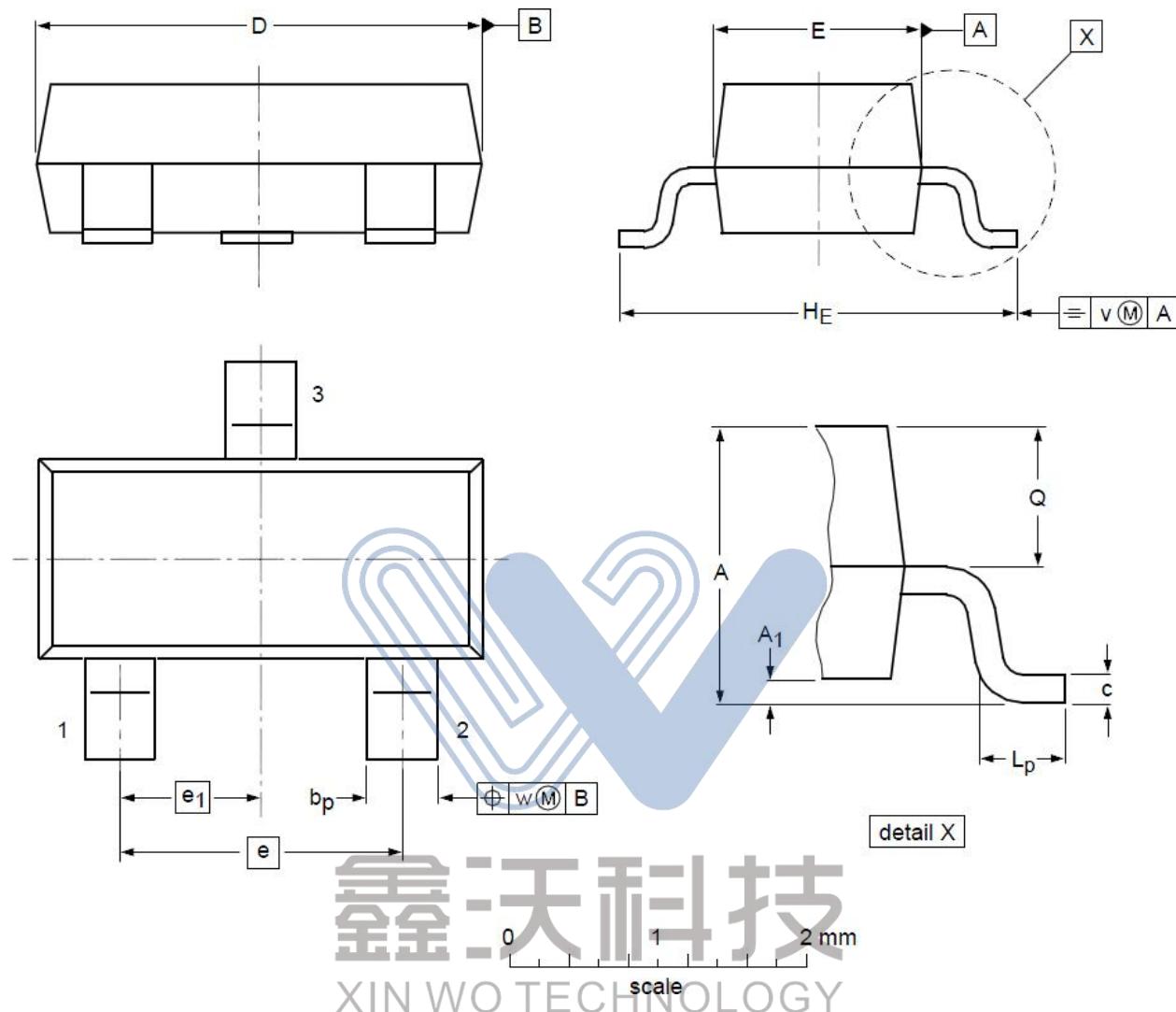


Fig10. Switching Time Test Circuit and waveforms

SOT23 Mechanical Data



DIMENSIONS (unit: mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.01	1.15	A ₁	0.01	0.05	0.10
b _p	0.30	0.42	0.50	c	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
e	--	1.90	--	e ₁	--	0.95	--
H _E	2.25	2.40	2.55	L _p	0.30	0.42	0.50
Q	0.45	0.49	0.55	v	--	0.20	--
w	--	0.10	--				